## **Low Power Quad Operational Amplifier**

IL2902/IL2902E

The IL2902/IL2902E contains four independent high gain operational amplifiers with internal frequency compensation. The four op-amps operate over a wide voltage range from a single power supply. Also use a split power supply. The device has low power supply current drain, regardless of the power supply voltage. The low power drain also makes the IL2902 /

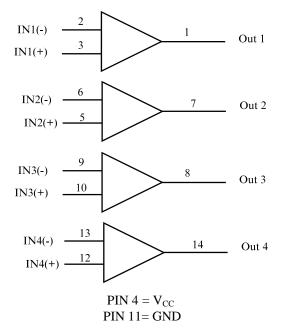
IL2902E a good choice for battery operation.

When your project calls for a traditional op-amp function, now you can streamline your design with a simple single power supply. Use ordinary +5VDC common to practically any digital system or personal computer application, without requiring an extra 15V power supply just to have the interface electronics you need.

The IL2902/IL2902E is a versatile, rugged workhorse with a thousand-and-one uses, from amplifying signals from a variety of transducers to dc gain blocks, or any op-amp function. The attached pages offer some recipes that will have your project cooking in no time.

- Internally frequency compensated for unity gain
- Large DC voltage gain: 100dB
- Wide power supply range:
  - $3V \sim 32V \; (\text{or} \; \pm 1.5V \sim \pm 16V)$
- Input common-mode voltage range includes ground
- Large output voltage swing: 0V DC to V<sub>CC</sub>-1.5V DC
- Power drain suitable for battery operation
- Low input offset voltage and offset current
- Differential input voltage range equal to the power supply voltage
- IL2902E AEC Q100 Qualified
- HBM ESD Level 7kV

# LOGIC DIAGRAM

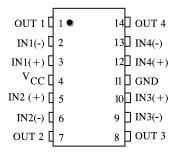


# N SUFFIX PLASTIC 1 D SUFFIX SOIC

#### ORDERING INFORMATION

IL2902N/NE Plastic IL2902D/DE SOIC for all packages.

#### PIN ASSIGNMENT





#### MAXIMUM RATINGS\*

Symbol	Parameter	Value	Unit
$V_{CC}$	Power Supply Voltages		
	Single Supply Split Supplies	32 ±16	V
V <sub>IDR</sub>	Input Differential Voltage Range (1)	±32	V
V <sub>ICR</sub>	Input Common Mode Voltage Range	-0.3 to 32	V
$I_{SC}$	Output Short Circuit Duration	Continuous	
$T_{J}$	Junction Temperature Plastic Packages	150	°C
Tstg	Storage Temperature Plastic Packages	-55 to +125	°C
I <sub>IN</sub>	Input Current, per pin (2)	50	mA
$T_{\rm L}$	Lead Temperature, 1mm from Case for 10 Seconds	260	°C

<sup>\*</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device.

Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C SOIC Package: : - 7 mW/°C from 65° to 125°C

#### Notes:

- 1. Split Power Supplies.
- 2.  $V_{IN}$ <-0.3V. This input current will only exist when voltage at any of the input leads is driven negative.

#### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
$V_{CC}$	DC Supply Voltage		±2.5 or 5.0	±15 or 30	V
T <sub>A</sub>	Operating Temperature, All Package Types	IL2902	-40	105	°C
		IL2902E	-40	125	

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{IN}$  and  $V_{OUT}$  should be constrained to the range  $GND \le (V_{IN}) \le V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{\text{CC}}$ ). Unused outputs must be left open.



These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

### **DC ELECTRICAL CHARACTERISTICS** ( $T_A$ = -40 to +125°C)

			Gua	ranteed L	imit	
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
$V_{IO}$	Maximum Input Offset Voltage	$V_{O}$ =1.4V $V_{CC}$ =5.0-30V; $R_{S}$ =0 $\Omega$ $V_{ICM}$ =0V to $V_{CC}$ -1.7V			9.0 5.0*	mV
$\Delta V_{IO}/\Delta T$	Input Offset Voltage Drift	$R_S=0\Omega$ , $V_{CC}=30V$		7.0		μV/°C
$I_{IO}$	Maximum Input Offset Current	V <sub>cc</sub> =5.0V			150 50*	nA
$\Delta I_{IO}/\Delta T$	Input Offset Current Drift	$R_S=0\Omega$ , $V_{CC}=30V$		10		pA/°C
$I_{IB}$	Maximum Input Bias Current	V <sub>CC</sub> =5.0V			500 250*	nA
$V_{ICR}$	Input Common Mode Voltage Range	V <sub>CC</sub> =30V	0		28	V
$I_{CC}$	Maximum Power Supply Current	$R_{L} = \infty, V_{CC} = 30V, V_{0} = 0V$ $R_{L} = \infty, V_{CC} = 5V, V_{0} = 0V$			3 1.2	mA
$A_{VOL}$	Minimum Large Signal Open-Loop Voltage Gain	$V_{CC}=15V, R_L \ge 2K\Omega$	15 25*			V/mV
$V_{\mathrm{OH}}$	Minimum Output High- Level Voltage Swing	$V_{CC}$ =30V, $R_L$ =2K $\Omega$ $V_{CC}$ =30V, $R_L$ =10K $\Omega$	26 27			V
$V_{OL}$	Maximum Output Low- Level Voltage Swing	$V_{CC}$ =5V, $R_L$ =10K $\Omega$			20	mV
CMR	Common Mode Rejection	$V_{CC}$ =30V, $R_S$ =10K $\Omega$	65*			dB
PSR	Power Supply Rejection	V <sub>CC</sub> =30V	65*			dB
CS	Channel Separation	f=1KHz to 20KHz,V <sub>CC</sub> =30V	-120*			dB
$I_{SC}$	Maximum Output Short Circuit to GND	V <sub>CC</sub> =5.0V			60*	mA
$I_{\text{source}}$	Minimum Output Source Current	$oxed{V_{IN+}=1V, V_{IN-}=0V, V_{CC}=15V, V_{0}=0V}$	10			mA
$I_{\rm sink}$	Minimum Output Sink Current	V <sub>IN+</sub> =0V, V <sub>IN-</sub> =1V, V <sub>CC</sub> =15V, V <sub>0</sub> =15V	5 10*			mA
		$V_{IN+}=0V, V_{IN-}=1V, V_{CC}=15V, V_0=15V$	12*			μΑ
$V_{\rm IDR}$	Differential Input Voltage Range	All V <sub>IN</sub> ≥GND or V-Supply (if used)			V <sub>CC</sub> *	V

<sup>\*=@25°</sup>C



#### TYPICAL PERFORMANCE CHARACTERISTICS

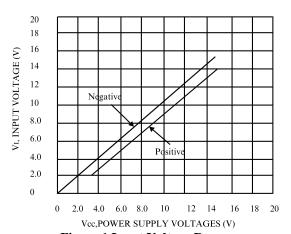


Figure 1.Input Voltage Range

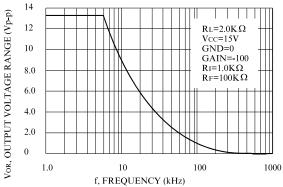


Figure 3. Large-Signal Frequency Response

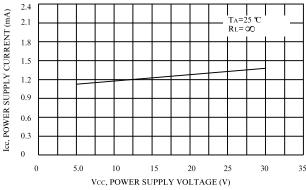


Figure 5. Power Supply Current versus Power Supply Voltage

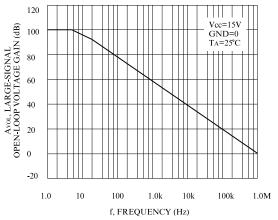


Figure 2. Open-Loop Frequency

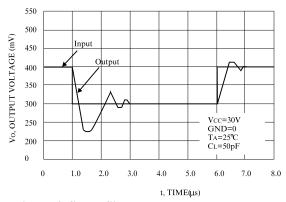


Figure 4. Small-Signal Voltage Follower Pulse Response (Noninverting)

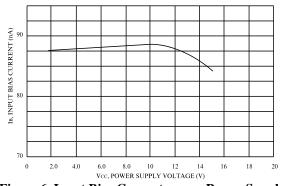
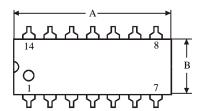
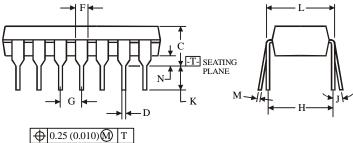


Figure 6. Input Bias Current versus Power Supply Voltage



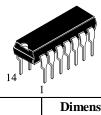
#### N SUFFIX PLASTIC DIP (MS - 001AA)





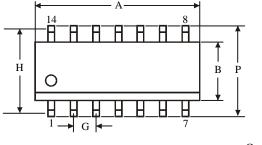
#### NOTES:

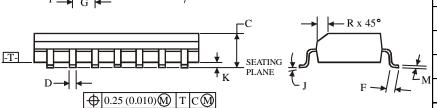
Dimensions "A", "B" do not include mold flash or protrusions.
 Maximum mold flash or protrusions 0.25 mm (0.010) per side.



	Dimension, mm			
Symbol	MIN MAX			
A	18.67 19.69			
В	6.1 7.11			
C		5.33		
D	0.36 0.56			
F	1.14	1.78		
G	2.54			
Н	7.62			
J	0° 10°			
<b>K</b> 2.92		3.81		
L	7.62 8.26			
M	0.2 0.36			
N	0.38			

#### D SUFFIX SOIC (MS - 012AB)





#### NOTES:

- 1. Dimensions A and B do not include mold flash or protrusion.
- 2. Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B 0.25 mm (0.010) per side.



	Dimension, mm			
Symbol	MIN	MAX		
A	8.55	8.75		
В	<b>B</b> 3.8			
C 1.35		1.75		
D	<b>D</b> 0.33			
F	0.4	1.27		
G	1.27			
Н	5.27			
J	0°	8°		
K	0.1	0.25		
M	0.19	0.25		
P	5.8	6.2		
R	0.25	0.5		

